Oocket No.:

005918 USA/FPS/MMCS/APC

PATENT/OFFICIAL

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

RECEIVED

SHANMUGASUNDRAM et al.

Serial No. 09/943,955

Group Art Unit: 2122

Technology Center 2100

Filed: August 31, 2001

: Examiner:

For:

FEEDBACK CONTROL OF A CHEMICAL MECHANICAL POLISHING DEVICE

PROVIDING MANIPULATION OF REMOVAL RATE PROFILES

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Honorable Commissioner for Patents Alexandria, VA 22313-1450

Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the documents listed on the attached form PTO-1449. It is respectfully requested that the documents be expressly considered during the prosecution of this application, and that the documents be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Information Disclosure Statement is being filed within three months of the U.S. filing date OR before the mailing date of a first Office Action on the merits. No certification or fee is required.

This submission does not constitute a representation that a search has been made or that no better art exists and does not constitute an admission or representation that any of the listed documents is material or constitutes prior art. If it should be determined that any of the listed documents does not constitute prior art under the United States law, Applicants reserve the right

Serial No. 09/943,955

to present to the Office the relevant facts and law regarding the appropriate status of such document.

No certification or fee is believed to be required. However, the Commissioner is hereby authorized to charge any additional fees should any be required for this submission, or credit any overpayment to deposit account no. 08-0219.

Respectfully submitted,

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CITATION IN AN									
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				APPLICANT SHANMUGASUNDRAM et al.					
				FILING DATE August 31, 2001		GROUP 2122			
EXAMINER'S INITIALS	PATENT NO.	DATE	NAME CLASS SUBCLAS			SUBCLASS	FILING DATE		
-	5,901,313	05/04/99	Wolf et al.			09/02/	97		
	6,002,989	12/14/99	Shiba et al.	<u> </u>		/FD	04/01/	97	
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EXAMINER'S INITIALS	PATENT NO.	DATE	со	UNTRY	CLASS	SUBCLASS	Translation		
							Yes	No	
	WO 99/59200	11/18/99	WIPO				Х		
	WO 01/52319	07/19/01	WIPO			ļ	X		
	OTHER	ART (Inclu	ding Author, Ti	tle, Date, Pertinent	Pages, Etc	<u> </u>	<u> </u>	<u> </u>	
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	20 August 2003. W	ritten Opinio							
EXAMINER	DATE CONSIDERED								

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.